TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHC86F,TC74VHC86FN,TC74VHC86FT,TC74VHC86FK

#### Quad Exclusive OR Gate

The TC74VHC86 is an advanced high speed CMOS QUAD EXCLUSIVE OR GATE fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

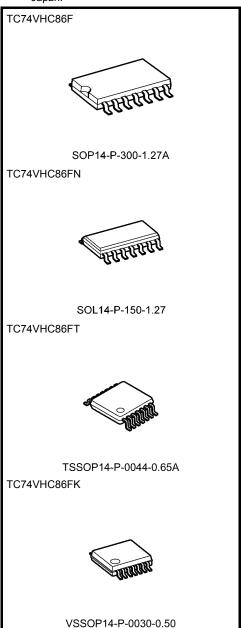
The internal circuit is includes on output buffer, which provide high noise immunity and stable output.

An Input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and on two supply system such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

- High speed:  $t_{pd} = 4.8 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC (min)}$
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC (opr)} = 2 V \text{ to } 5.5 V$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS86

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

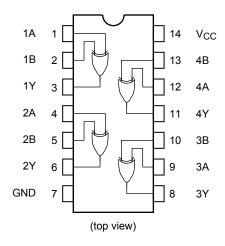
 SOP14-P-300-1.27A
 : 0.18 g (typ.)

 SOL14-P-150-1.27
 : 0.12 g (typ.)

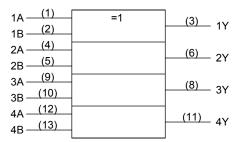
 TSSOP14-P-0044-0.65A
 : 0.06 g (typ.)

 VSSOP14-P-0030-0.50
 : 0.02 g (typ.)

### **Pin Assignment**



## **IEC Logic Symbol**



#### **Truth Table**

Α	В	Υ
L	L	L
L	Н	Н
Н	L	Н
Н	Н	L

### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lık	-20	mA
Output diode current	Гок	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stq</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



# **Operating Ranges (Note)**

Characteristics	Symbol	pol Rating		
Supply voltage	$V_{CC}$	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = $3.3 \pm 0.3$ V)	ns/V	
input rise and rail time	ui/uv	0 to 20 (V <sub>CC</sub> = $5 \pm 0.5$ V)		

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

### **Electrical Characteristics**

### **DC Characteristics**

Characteristics Symbol		Test Condition			٦	a = 25°C		Ta = -40 to 85°C		
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0 3.0 to 5.5	1.50 V <sub>CC</sub> × 0.7			1.50 V <sub>CC</sub> × 0.7		V
Low-level input voltage	$V_{IL}$	_		2.0 3.0 to 5.5			0.50 V <sub>CC</sub> × 0.3	_	0.50 V <sub>CC</sub> × 0.3	V
High-level output voltage	V <sub>ОН</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -50 \mu A$ $I_{OH} = -4 \text{ mA}$	2.0 3.0 4.5 3.0	1.9 2.9 4.4 2.58	2.0 3.0 4.5		1.9 2.9 4.4 2.48		<b>V</b>
			I <sub>OH</sub> = -8 mA	4.5	3.94	_	_	3.80	_	
Low-level output voltage V <sub>OL</sub>	V <sub>OL</sub>	$V_{OL}$ $V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 50 μA	2.0 3.0 4.5 3.0	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1 0.36	_ _ _	0.1 0.1 0.1	٧
			I <sub>OL</sub> = 8 mA	4.5	_		0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5			±0.1	_	±1.0	μА
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	2.0	_	20.0	μА

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### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics Symbol	Symbol	Te	st Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	Symbol		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	Offic
time			3.3 ± 0.3	15	_	7.0	11.0	1.0	13.0	ns ns
	t <sub>pLH</sub>			50	_	9.5	14.5	1.0	16.5	
	t <sub>pHL</sub>	_	5.0 ± 0.5	15	_	4.8	6.8	1.0	8.0	
		3.0 ± 0.3	50	_	6.3	8.8	1.0	10.0		
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note)		18		_		pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

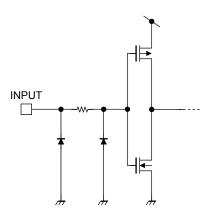
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$ 

### Noise Characteristics (input: $t_r = t_f = 3$ ns)

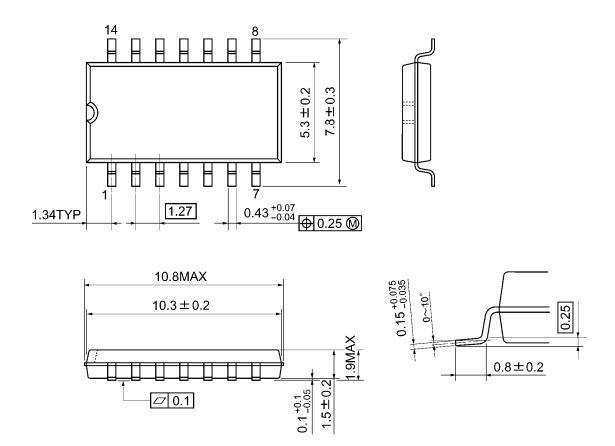
Characteristics	Symbol	Test Condition		Ta = 25°C		
		Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.3	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.3	-0.8	٧
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	٧
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

### **Input Equivalent Circuit**



# **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



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Weight: 0.18 g (typ.)

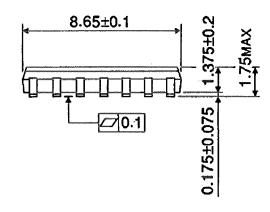
Unit: mm

# **Package Dimensions (Note)**

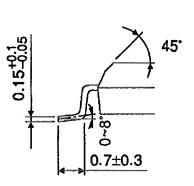
SOL14-P-150-1.27

14 月月月 目目 B 7 0.515TYP 0.42±0.07

**⊕** 0.25 **ω** 



1.27



Note: This package is not available in Japan.

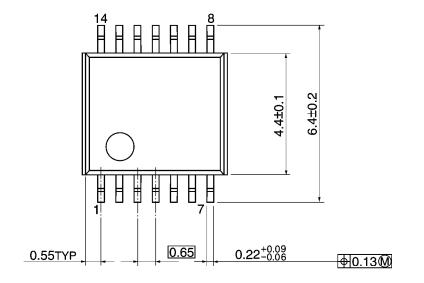
Weight: 0.12 g (typ.)

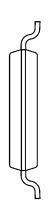
6

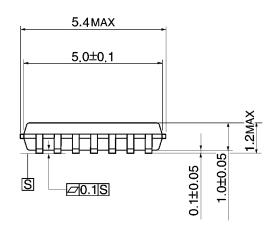
# **Package Dimensions**

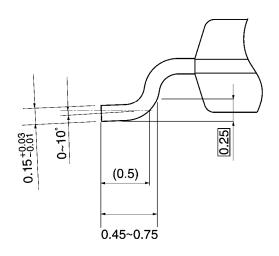
TSSOP14-P-0044-0.65A

Unit: mm





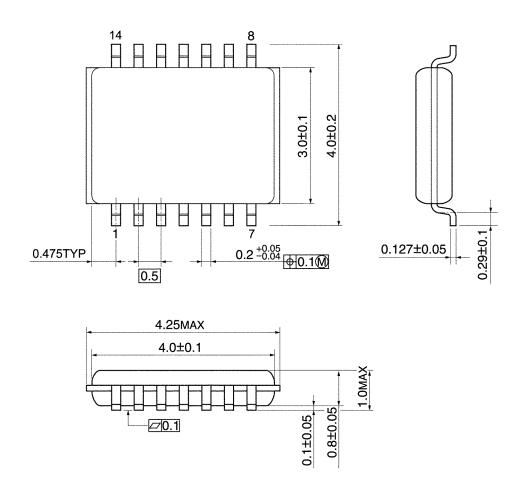




Weight: 0.06 g (typ.)

# **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



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Weight: 0.02 g (typ.)

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